

Declaration for U.S. Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled

PROTON-CONDUCTING MEMBRANE, METHOD FOR PRODUCING THE SAME, AND FUEL CELL USING THE SAME

the specification of which is attached hereto unless the following is checked

██████████ was filed on January 8, 2002 as United States Application Number 10/038,875.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) - (d) of any foreign applications for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed:

(List prior foreign applications. See note A on back of this page)	2001-1862 (Number)	Japan (Country)	9 January 2001 (Day/Month/Year Filed)	Priority Claimed <u>XX</u> Yes <u> </u> No
	2001-269067 (Number)	Japan (Country)	5 September 2001 (Day/Month/Year Filed)	<u>XX</u> Yes <u> </u> No
	2002-10 (Number)	Japan (Country)	4 January 2002 (Day/Month/Year Filed)	<u>XX</u> Yes <u> </u> No
				<u> </u> Yes <u> </u> No

(See note B on back of this page)

See attached list for additional prior foreign applications

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(List Prior U.S. Applications)	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)
--------------------------------	---------------------	---------------	--

10/038,875

I hereby appoint the following attorney and/or agent(s) to prosecute this application to transact all business in the Patent and Trademark Office connected therewith:



23850

PATENT TRADEMARK OFFICE

Please direct all communications to the following address:



23850

PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor Itaru HONMA

Inventor's signature *Itaru Honma* Date March 26, 2002

Residence Tsukuba-shi, Japan

Citizenship Japanese

Post Office Address AIST Tsukuba Central 2, National Institute of Advanced Industrial Science and Technology, 1-1, Umezono 1-chome, Tsukuba-shi, Ibaraki-ken, 305-8568, Japan

Full name of second inventor (given name, family name) Shigeki NOMURA

Inventor's signature *Shigeki Nomura* Date Mar. 26, 2002

Residence Tsukuba-shi, Japan Citizenship Japanese

Post Office Address Sekisui Chemical Co.,Ltd., 32, Wadai, Tsukuba-shi, Ibaraki-ken, 300-4292, Japan

Full name of third inventor (given name, family name) Toshiya SUGIMOTO

Inventor's signature *Toshiya Sugimoto* Date Mar. 25, 2002

Residence Tsukuba-shi, Japan Citizenship Japanese

Post Office Address Sekisui Chemical Co.,Ltd., 32, Wadai, Tsukuba-shi, Ibaraki-ken, 300-4292, Japan

Full name of fourth inventor (given name, family name) Osamu NISHIKAWA

Inventor's signature *Osamu Nishikawa* Date Mar. 25, 2002

Residence Tsukuba-shi, Japan Citizenship Japanese

Post Office Address Sekisui Chemical Co.,Ltd., 32, Wadai, Tsukuba-shi, Ibaraki-ken, 300-4292, Japan